

#### **Features**

- · 3rd generation SiC MOSFET technology
- · Optimized package with separate driver source pin
- · High blocking voltage with low on-resistance
- · High-speed switching with low capacitances
- · Fast intrinsic diode with low reverse recovery (Q<sub>rr</sub>)
- · Halogen free, RoHS compliant

#### **Benefts**

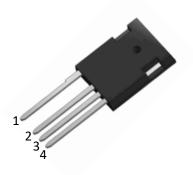
- · Reduce switching losses and minimize gate ringing
- · Higher system effciency
- · Reduce cooling requirements
- · Increase power density
- · Increase system switching frequency

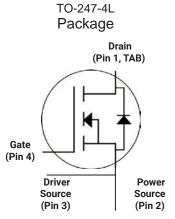
### **Applications**

- · Renewable energy
- · EV battery chargers
- · High voltage DC/DC converters
- Switch Mode Power Supplies

Ordering Part Number	Package	Marking	
HC3M0030065K	TO-247-4L	HC3M0030065K	







# **Maximum Ratings** ( $T_C = 25$ °C unless otherwise specifed)

Parameter	Symbol	Value	Unit
Drain-source voltage	Vds	650	V
Continuous drain current  Tc = 25°C  Tc = 100°C	al	97 69	А
Pulsed drain current (Tc = 25°C, tp limited by T <sub>jmax</sub> )	ID pulse	241	Α
Avalanche energy, single pulse (L=10mH)	Eas	1620	mJ
Gate-Source voltage	Vgs	-5/+20	V
Gate-Source voltage(dynamic,Absolute maximum values)	VGSmax	-10/+25	V
Power dissipation (Tc = 25°C)	Ptot	429	W
Operating junction and storage temperature	Tj , Tstg	-55+175	°C



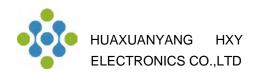
Electrical Characteristic (at Tj = 25 °C, unless otherwise specified)

Parameter	Symbol	<u> </u>	Value			Test Condition	
ai ai i i e le i	Syllibol	min.	typ.	max.	Unit	rest Condition	
Static Characteristic							
Drain-source breakdown voltage	BVoss	650	-	-	V	Vgs=0V, In=250uA	
Gate threshold voltage	VGS(th)	2	-	4	V	Vps=Vgs,lp=15mA	
Zero gate voltage drain current	loss		1 10	100	μА	Vps=650V,Vgs=0V T <sub>j</sub> =25°C T <sub>j</sub> =175°C	
Gate-source leakage current	Igss	-		250	nA	Vgs=20V,Vps=0V	
	1	-	30	-		Vgs=18V, ID=33.5A,	
Drain-source on-state resistance	RDS(on)	-	25 34	45 -	m	Vgs=20V, Id=33.5A, Tj=25°C Tj=175°C	
Transconductance	<b>g</b> fs	-	5.6	-	S	Vps=20V,lp=17.6A	
Dynamic Characteristic				<u> </u>		L	
Input Capacitance	Ciss	-	3280	-		Vps = 650V	
Output Capacitance	Coss	-	359	-	pF	V <sub>G</sub> s = 0V T <sub>J</sub> = 25°C	
Reverse Transfer Capacitance	Crss	-	33	-		Vac = 25mV f = 1MHz	
Gate Total Charge	QG	-	172	-		Vps = 400V	
Gate-Source charge	Qgs	-	41	-	nC	Vgs = -5/20V Ip = 33.5A	
Gate-Drain charge	Qgd	-	38	-		ID = 33.5A	
Turn-On Switching Energy	Eon	-	478	-	11.1	V <sub>DD</sub> = 400V V <sub>GS</sub> = -5/+20V I <sub>D</sub> = 33.5A R <sub>G</sub> = 10	
Turn-Off Switching Energy-	Eoff	-	115		μJ		
Turn-on delay time	t <sub>d(on)</sub>	-	32	-	ne		
Rise time	tr	-	44	-			
Turn-off delay time	td(off)	-	84	-	ns	L = 100uH	
Fall time	<b>t</b> f	-	22	-			
Gate resistance	Rg	-	1.1	-		Vac = 25mV, f=1MHz	



# **Body Diode Characteristic**

Parameter	Symbol	Value			Unit	Test Condition	
l arameter	Syllibol	min.	min. typ. max.		) iii	rest Condition	
Body Diode Forward Voltage	Vsp		3.2		V	Vgs=0V,Isp=8.8A, Tj=25°C	
Body Diode Polward Voltage	V 3D		2.6			Vgs=0V,Isp=8.8A, TJ=175°C	
Continuous Diode Forward Current	ls		83		А	Vgs= 4V,Tc =25°C	
Body Diode Reverse Recovery Time	trr	-	40	-	ns	Vr = 400V, Ip = 17.6A	
Body Diode Reverse Recovery Charge	Qrr	-	156	-	nC	di/dt = 1000A/μS	



### **Typical Performance Characteristics**

Fig 1. Output Characteristic (T<sub>J</sub>=-55°C)

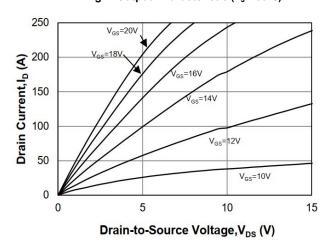
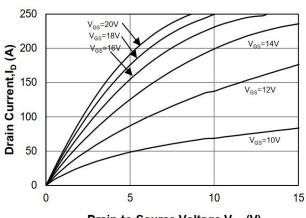


Fig 2. Output Characteristic (T<sub>J</sub>=25℃)



Drain-to-Source Voltage, V<sub>DS</sub> (V)

Fig 3. Output Characteristic (T $_J$ =175 $^{\circ}$ C)

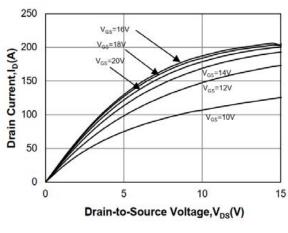


Fig 4: Rdson Vs Ids Characteristic

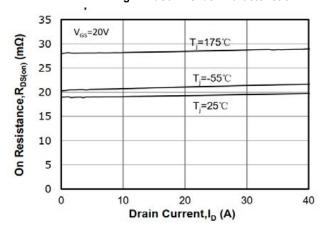


Fig 5: Rds(on) vs. Temperature

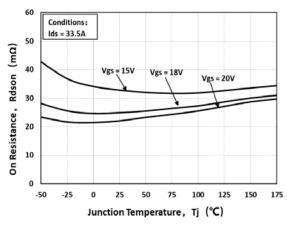
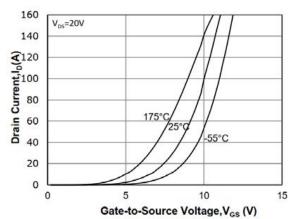
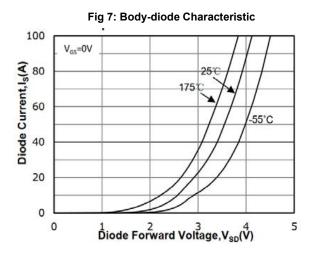
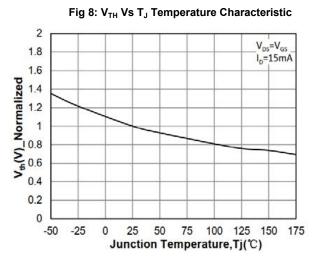


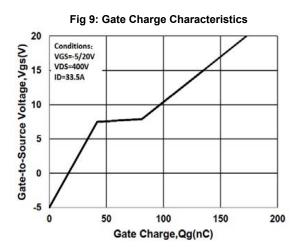
Fig 6: Transfer Characteristic

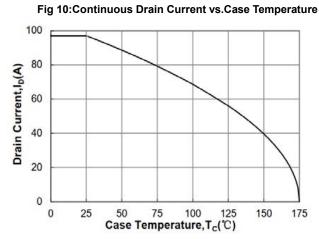


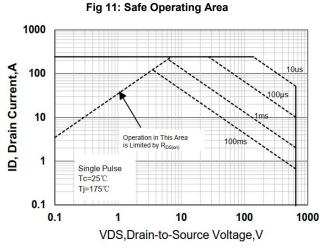


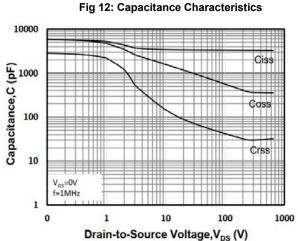














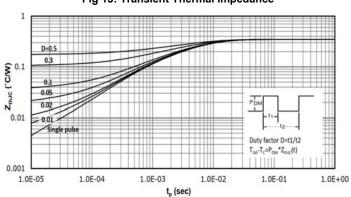


Fig 13: Transient Thermal Impedance

### **Test Circuit & Waveform**

Figure A. Definition of switching times

 $V_{\rm DS}$  90%  $V_{\rm GS}$  10%  $t_{\rm d(on)} t_{\rm f}$   $t_{\rm on} t_{\rm off}$ 

Figure B. Dynamic test circuit

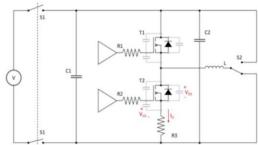
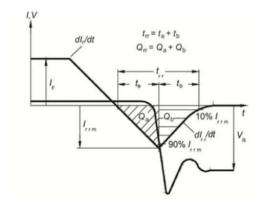


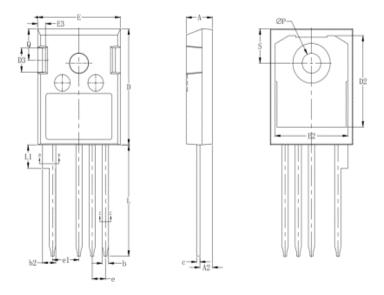
Figure C. Definition of body diodeswitching characteristics





## **Package Dimensions**

Package TO-247-4L



Items	Values(mm)				
Items	MIN	MAX			
Α	4.8	5.2			
A2	2.2	2.6			
b	1.05	1.4			
b2	2.4	2.75			
С	0.5	0.75			
D	20	21.5			
D2	15.5	17.2			
D3	4	5			
E	15.5	16.1			
E2	13	15			
E3	1	2			
е	2.54 BSC.				
e1	5.08 BSC.				
L	19	21			
L1	4	4.45			
ФР	3.5	3.7			
Q	5.4	5.9			
S	5.9 6.4				



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